

**Product data sheet** 

# 1. General description

The 74HC00; 74HCT00 is a quad 2-input NAND gate. Inputs include clamp diodes. This enables the use of current limiting resistors to interface inputs to voltages in excess of  $V_{CC}$ .

### 2. Features and benefits

- Wide supply voltage range from 2.0 to 6.0 V
- CMOS low power dissipation
- High noise immunity
- Latch-up performance exceeds 100 mA per JESD 78 Class II Level B
- Input levels:
  - For 74HC00: CMOS level
  - For 74HCT00: TTL level
- Complies with JEDEC standards:
  - JESD8C (2.7 V to 3.6 V)
  - JESD7A (2.0 V to 6.0 V)
- ESD protection:
  - HBM: ANSI/ESDA/JEDEC JS-001 class 2 exceeds 2000 V
  - CDM: ANSI/ESDA/JEDEC JS-002 class C3 exceeds 1000 V
- Multiple package options
- Specified from -40 °C to +85 °C and from -40 °C to +125 °C

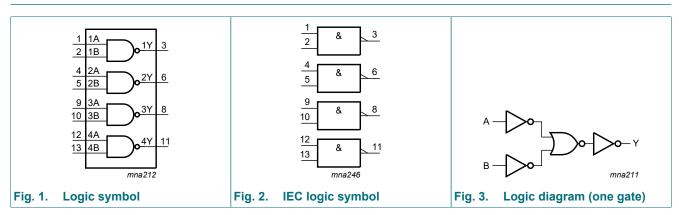
## 3. Ordering information

#### Table 1. Ordering information

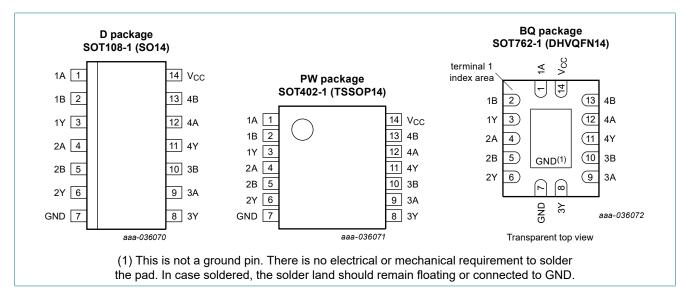
Type number	Package	Package							
	Temperature range	Name	lame Description						
74HC00D 74HCT00D	-40 °C to +125 °C	SO14	plastic small outline package; 14 leads; body width 3.9 mm	<u>SOT108-1</u>					
74HC00PW 74HCT00PW	-40 °C to +125 °C	TSSOP14	plastic thin shrink small outline package; 14 leads; body width 4.4 mm	<u>SOT402-1</u>					
74HC00BQ 74HCT00BQ	-40 °C to +125 °C	DHVQFN14	plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 14 terminals; body 2.5 × 3 × 0.85 mm	<u>SOT762-1</u>					

# nexperia

# 4. Functional diagram



# 5. Pinning information



### 5.1. Pinning

### 5.2. Pin description

Symbol	Pin	Description
1A, 2A, 3A, 4A	1, 4, 9, 12	data input
1B, 2B, 3B, 4B	2, 5, 10, 13	data input
1Y, 2Y, 3Y, 4Y	3, 6, 8, 11	data output
GND	7	ground (0 V)
V <sub>CC</sub>	14	supply voltage

## 6. Functional description

#### Table 3. Function table

H = HIGH voltage level; L = LOW voltage level; X = don't care.

Input	Output	
nA	nB	nY
L	X	Н
Х	L	Н
Н	Н	L

## 7. Limiting values

#### Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CC</sub>	supply voltage		-0.5	+7	V
I <sub>IK</sub>	input clamping current	$V_{I} < -0.5 V \text{ or } V_{I} > V_{CC} + 0.5 V$ [1]	-	±20	mA
I <sub>OK</sub>	output clamping current	$V_{\rm O}$ < -0.5 V or $V_{\rm O}$ > $V_{\rm CC}$ + 0.5 V [1]	-	±20	mA
I <sub>O</sub>	output current	$-0.5 V < V_O < V_{CC} + 0.5 V$	-	±25	mA
I <sub>CC</sub>	supply current		-	50	mA
I <sub>GND</sub>	ground current		-50	-	mA
T <sub>stg</sub>	storage temperature		-65	+150	°C
P <sub>tot</sub>	total power dissipation	[2]	-	500	mW

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] For SOT108-1 (SO14) package: P<sub>tot</sub> derates linearly with 10.1 mW/K above 100 °C.

For SOT402-1 (TSSOP14) package:  $\mathsf{P}_{tot}$  derates linearly with 7.3 mW/K above 81 °C.

For SOT762-1 (DHVQFN14) package:  $\mathsf{P}_{tot}$  derates linearly with 9.6 mW/K above 98 °C.

## 8. Recommended operating conditions

#### Table 5. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V)

Symbol	Parameter	Conditions	74HC00		74HCT00			Unit	
			Min	Тур	Мах	Min	Тур	Max	
V <sub>CC</sub>	supply voltage		2.0	5.0	6.0	4.5	5.0	5.5	V
VI	input voltage		0	-	V <sub>CC</sub>	0	-	V <sub>CC</sub>	V
Vo	output voltage		0	-	V <sub>CC</sub>	0	-	V <sub>CC</sub>	V
T <sub>amb</sub>	ambient temperature		-40	+25	+125	-40	+25	+125	°C
Δt/ΔV	input transition rise and fall rate	V <sub>CC</sub> = 2.0 V	-	-	625	-	-	-	ns/V
		V <sub>CC</sub> = 4.5 V	-	1.67	139	-	1.67	139	ns/V
		V <sub>CC</sub> = 6.0 V	-	-	83	-	-	-	ns/V

# 9. Static characteristics

#### Table 6. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		25 °C		-40 °C t	o +85 °C	-40 °C to +125 °C		Unit
			Min	Тур	Max	Min	Мах	Min	Max	
74HC00	1						1		1	
V <sub>IH</sub>	HIGH-level	V <sub>CC</sub> = 2.0 V	-	1.2	-	1.5	-	1.5	-	V
input voltage	V <sub>CC</sub> = 4.5 V	-	2.4	-	3.15	-	3.15	-	V	
		V <sub>CC</sub> = 6.0 V	-	3.2	-	4.2	-	4.2	-	V
V <sub>IL</sub>	LOW-level	V <sub>CC</sub> = 2.0 V	-	0.8	-	-	0.5	-	0.5	V
	input voltage	V <sub>CC</sub> = 4.5 V	-	2.1	-	-	1.35	-	1.35	V
		V <sub>CC</sub> = 6.0 V	-	2.8	-	-	1.8	-	1.8	V
V <sub>OH</sub>	HIGH-level	$V_{I} = V_{IH}$ or $V_{IL}$								
	output voltage	I <sub>O</sub> = -20 μA; V <sub>CC</sub> = 2.0 V	-	2.0	-	1.9	-	1.9	-	V
		I <sub>O</sub> = -20 μA; V <sub>CC</sub> = 4.5 V	-	4.5	-	4.4	-	4.4	-	V
		I <sub>O</sub> = -20 μA; V <sub>CC</sub> = 6.0 V	-	6.0	-	5.9	-	5.9	-	V
		I <sub>O</sub> = -4.0 mA; V <sub>CC</sub> = 4.5 V	-	4.32	-	3.84	-	3.7	-	V
		I <sub>O</sub> = -5.2 mA; V <sub>CC</sub> = 6.0 V	-	5.81	-	5.34	-	5.2	-	V
V <sub>OL</sub>	LOW-level	$V_{I} = V_{IH}$ or $V_{IL}$								
out	output voltage	I <sub>O</sub> = 20 μA; V <sub>CC</sub> = 2.0 V	-	0	-	-	0.1	-	0.1	V
		I <sub>O</sub> = 20 μA; V <sub>CC</sub> = 4.5 V	-	0	-	-	0.1	-	0.1	V
		I <sub>O</sub> = 20 μA; V <sub>CC</sub> = 6.0 V	-	0	-	-	0.1	-	0.1	V
		I <sub>O</sub> = 4.0 mA; V <sub>CC</sub> = 4.5 V	-	0.15	-	-	0.33	-	0.4	V
		I <sub>O</sub> = 5.2 mA; V <sub>CC</sub> = 6.0 V	-	0.16	-	-	0.33	-	0.4	V
lı	input leakage current	$V_1 = V_{CC}$ or GND; $V_{CC} = 6.0$ V	-	-	-	-	±1	-	±1	μA
I <sub>CC</sub>	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 6.0$ V	-	-	-	-	20	-	40	μA
CI	input capacitance		-	3.5	-	-	-	-	-	pF
74HCT0	0	1	1	1	1				1	
V <sub>IH</sub>	HIGH-level input voltage	$V_{CC}$ = 4.5 V to 5.5 V	-	1.6	-	2.0	-	2.0	-	V
V <sub>IL</sub>	LOW-level input voltage	$V_{CC}$ = 4.5 V to 5.5 V	-	1.2	-	-	0.8	-	0.8	V
V <sub>OH</sub>	HIGH-level	$V_{I} = V_{IH}$ or $V_{IL}$ ; $V_{CC} = 4.5 V$								
	output voltage	Ι <sub>O</sub> = -20 μΑ	-	4.5	-	4.4	-	4.4	-	V
		I <sub>O</sub> = -4.0 mA	-	4.32	-	3.84	-	3.7	-	V
V <sub>OL</sub>	LOW-level	$V_{I} = V_{IH} \text{ or } V_{IL}; V_{CC} = 4.5 \text{ V}$								
	output voltage	I <sub>O</sub> = 20 μA	-	0	-	-	0.1	-	0.1	V
		I <sub>O</sub> = 4 mA	-	0.15	-	-	0.33	-	0.4	V

# 74HC00; 74HCT00

#### **Quad 2-input NAND gate**

Symbol	Symbol Parameter Conditions			25 °C		-40 °C to	o +85 °C	-40 °C to +125 °C		Unit
			Min	Тур	Мах	Min	Max	Min	Мах	
l <sub>l</sub>	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 6.0 V$	-	-	-	-	±1	-	±1	μA
I <sub>CC</sub>	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 6.0$ V	-	-	-	-	20	-	40	μA
ΔI <sub>CC</sub>	additional supply current	per input pin; $V_I = V_{CC} - 2.1 \text{ V}; I_O = 0 \text{ A};$ other inputs at $V_{CC}$ or GND; $V_{CC} = 4.5 \text{ V}$ to 5.5 V	-	150	-	-	675	-	735	μA
CI	input capacitance		-	3.5	-	-	-	-	-	pF

## 10. Dynamic characteristics

#### Table 7. Dynamic characteristics

GND = 0 V;  $C_L = 50 pF$ ; for test circuit see Fig. 5.

Symbol	Parameter	Conditions			25 °C		-40 °C to +85 °C		-40 °C to +125 °C		Unit
		-		Min	Тур	Мах	Min	Мах	Min	Max	
74HC00									-		
t <sub>pd</sub>	propagation	nA, nB to nY; see Fig. 4	[1]								
	delay	V <sub>CC</sub> = 2.0 V		-	25	-	-	115	-	135	ns
		V <sub>CC</sub> = 4.5 V		-	9	-	-	23	-	27	ns
		V <sub>CC</sub> = 5.0 V; C <sub>L</sub> = 15 pF		-	7	-	-	-	-	-	ns
		V <sub>CC</sub> = 6.0 V		-	7	-	-	20	-	23	ns
t <sub>t</sub>	transition	see Fig. 4	[2]								
	time	V <sub>CC</sub> = 2.0 V		-	19	-	-	95	-	110	ns
		V <sub>CC</sub> = 4.5 V		-	7	-	-	19	-	22	ns
		V <sub>CC</sub> = 6.0 V		-	6	-	-	16	-	19	ns
C <sub>PD</sub>	power dissipation capacitance	per package; V <sub>I</sub> = GND to V <sub>CC</sub>	[3]	-	22	-	-	-	-	-	pF
74HCT0	0						1	1	1		1
t <sub>pd</sub>	propagation	nA, nB to nY; see Fig. 4	[1]								
	delay	V <sub>CC</sub> = 4.5 V		-	12	-	-	24	-	29	ns
		V <sub>CC</sub> = 5.0 V; C <sub>L</sub> = 15 pF		-	10	-	-	-	-	-	ns
t <sub>t</sub>	transition time	V <sub>CC</sub> = 4.5 V; see <u>Fig. 4</u>	[2]	-	-	-	-	29	-	22	ns
C <sub>PD</sub>	power dissipation capacitance	per package; V <sub>I</sub> = GND to V <sub>CC</sub> - 1.5 V	[3]	-	22	-	-	-	-	-	pF

t<sub>pd</sub> is the same as t<sub>PHL</sub> and t<sub>PLH</sub>.
 t<sub>t</sub> is the same as t<sub>THL</sub> and t<sub>TLH</sub>.
 C<sub>PD</sub> is used to determine the dynamic power dissipation (P<sub>D</sub> in μW):

 $P_{D} = C_{PD} \times V_{CC}^{2} \times f_{i} \times N + \Sigma (C_{L} \times V_{CC}^{2} \times f_{o}) \text{ where:}$ 

 $f_i$  = input frequency in MHz;  $f_o$  = output frequency in MHz;

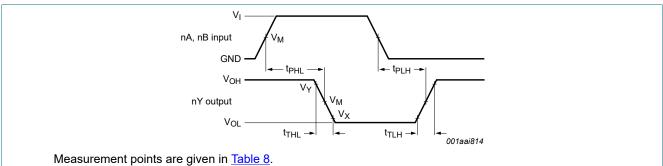
 $C_L$  = output load capacitance in pF;

V<sub>CC</sub> = supply voltage in V;

N = number of inputs switching;

 $\Sigma (C_L \times V_{CC}^2 \times f_o) = \text{sum of outputs.}$ 

### 10.1. Waveforms and test circuit

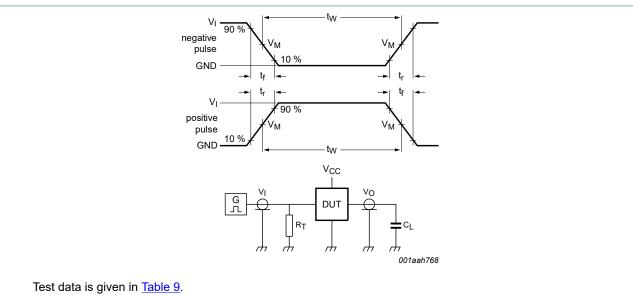


 $V_{\text{OL}}$  and  $V_{\text{OH}}$  are typical voltage output levels that occur with the output load.

#### Fig. 4. Input to output propagation delays

#### Table 8. Measurement points

Туре	Input	Output				
	V <sub>M</sub>	V <sub>M</sub> V <sub>X</sub> V <sub>Y</sub>				
74HC00	0.5V <sub>CC</sub>	0.5V <sub>CC</sub>	0.1V <sub>CC</sub>	0.9V <sub>CC</sub>		
74HCT00	1.3 V	1.3 V	0.1V <sub>CC</sub>	0.9V <sub>CC</sub>		



Definitions test circuit:

 $R_T$  = termination resistance should be equal to output impedance  $Z_o$  of the pulse generator.

C<sub>L</sub> = load capacitance including jig and probe capacitance.

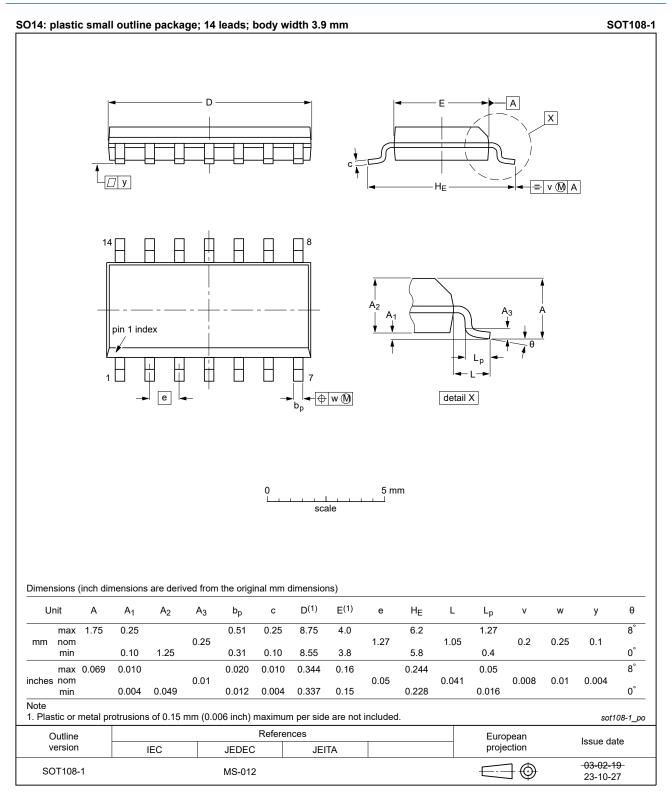
#### Fig. 5. Test circuit for measuring switching times

<b>11</b> - 11 - 11	•	<b>T</b>	1.1.1.1.1
Table	9.	lest	data

Туре	Input L		Load	Test
	VI	t <sub>r</sub> , t <sub>f</sub>	CL	
74HC00	V <sub>CC</sub>	6.0 ns	15 pF, 50 pF	t <sub>PLH</sub> , t <sub>PHL</sub>
74HCT00	3.0 V	6.0 ns	15 pF, 50 pF	t <sub>PLH</sub> , t <sub>PHL</sub>

#### **Quad 2-input NAND gate**

# **11. Package outline**



#### Fig. 6. Package outline SOT108-1 (SO14)

# 74HC00; 74HCT00

#### **Quad 2-input NAND gate**

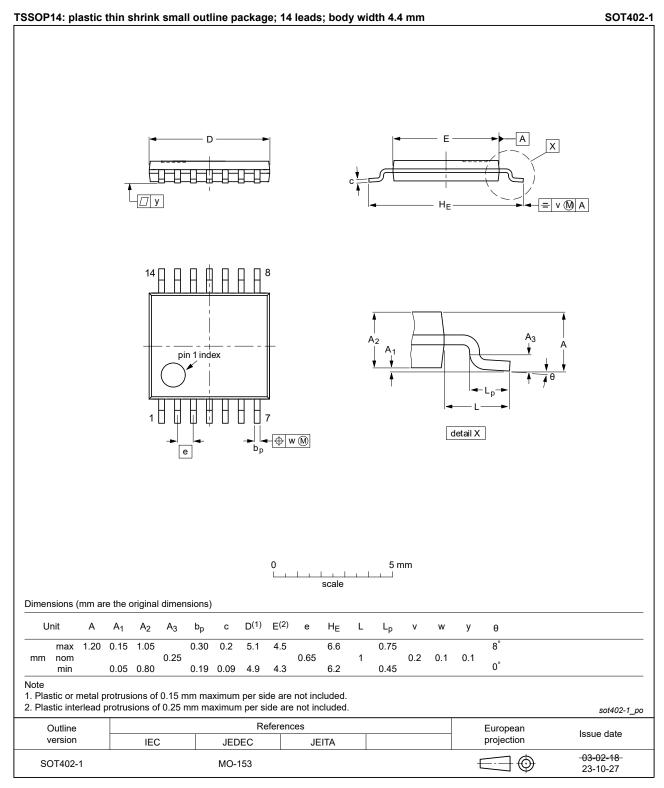


Fig. 7. Package outline SOT402-1 (TSSOP14)

# 74HC00; 74HCT00

#### **Quad 2-input NAND gate**

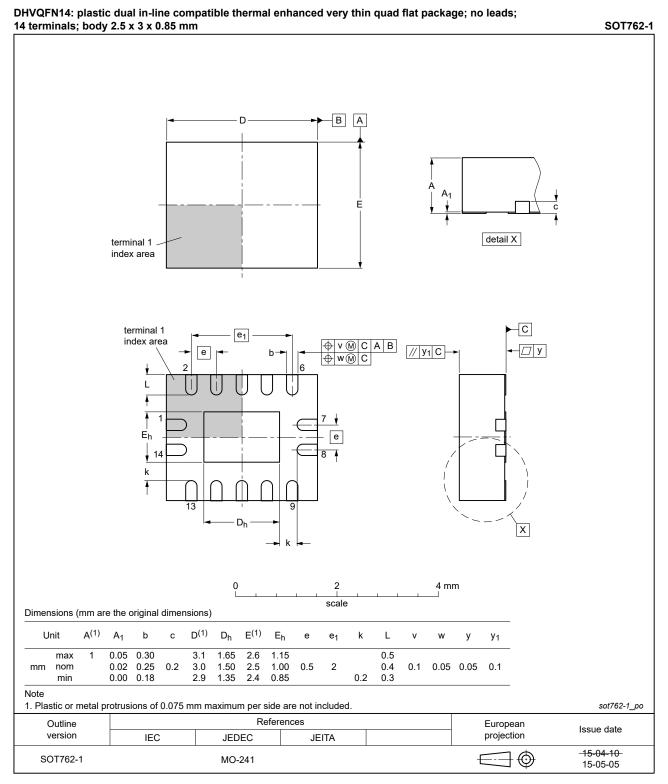


Fig. 8. Package outline SOT762-1 (DHVQFN14)

# 12. Abbreviations

Table 10. Abbreviations				
Acronym	Description			
CDM	Charged Device Model			
CMOS	Complementary Metal-Oxide Semiconductor			
DUT	Device Under Test			
ESD	ElectroStatic Discharge			
HBM	Human Body Model			
TTL	Transistor-Transistor Logic			

# 13. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes		
74HC_HCT00 v.10	20240215	Product data sheet	-	74HC_HCT00 v.9		
Modifications:		<ul> <li><u>Section 2</u>: ESD specification updated according to the latest JEDEC standard.</li> <li><u>Fig. 6</u>, <u>Fig. 7</u>: Aligned SO and TSSOP package outline drawings to JEDEC MS-012 and MO-153</li> </ul>				
74HC_HCT00 v.9	20211022	Product data sheet	-	74HC_HCT00 v.8		
Modifications:	• <u>Section 9</u> : \	<u>Section 9</u> : V <sub>OL</sub> condition for 74HCT00 corrected. (Errata)				
74HC_HCT00 v.8	20210810	Product data sheet	-	74HC_HCT00 v.7		
	<ul> <li>The format of this data sheet has been redesigned to comply with the identity guidelines of Nexperia.</li> <li>Legal texts have been adapted to the new company name where appropriate.</li> <li>Type numbers 74HC00DB and 74HCT00DB (SOT337-1/SSOP14) removed.</li> <li><u>Section 2</u> updated.</li> <li><u>Section 7</u>: Derating values for P<sub>tot</sub> total power dissipation have been updated.</li> </ul>					
74HC_HCT00 v.7	20151125	Product data sheet	-	74HC_HCT00 v.6		
Modifications:	Type numbers 74HC00N and 74HCT00N (SOT27-1) removed.					
74HC_HCT00 v.6	20111214	Product data sheet	-	74HC_HCT00 v.5		
Modifications:	Legal pages updated.					
74HC_HCT00 v.5	20101125	Product data sheet	-	74HC_HCT00 v.4		
74HC_HCT00 v.4	20100111	Product data sheet	-	74HC_HCT00 v.3		
74HC_HCT00 v.3	20030630	Product data sheet	-	74HC_HCT00_CNV v.2		
74HC_HCT00_CNV v.2	19970826	Product specification	-	-		

# 14. Legal information

#### Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

 Please consult the most recently issued document before initiating or completing a design.

- [2] The term 'short data sheet' is explained in section "Definitions".
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#### **Quad 2-input NAND gate**

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